Power MOSFET

30 V, 23 A, Single N-Channel, SO₋₈ Flat Lead

Features

- Low R_{DS(on)}
- Low Inductance SO-8 Package
- These are Pb-Free Devices

Applications

- Notebooks, Graphics Cards
- DC-DC Converters
- Synchronous Rectification

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	30	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain Current	Steady	$T_A = 25^{\circ}C$	I _D	14	А	
(Note 1)	State	T _A = 85°C		10		
	$t \le 10 s$	$T_A = 25^{\circ}C$		23		
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	2.2	W	
	$t \le 10 s$			5.8		
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$	I _D	9.1	А	
(Note 2)		T _A = 85°C		6.5		
Power Dissipation (Note 2)		$T_A = 25^{\circ}C$		0.9	W	
Pulsed Drain Current	t _p =	10 μs	I _{DM}	68	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C	
Source Current (Body Diode)			۱ _S	7.0	А	
Single Pulse Drain-to-Source Avalanche Energy (V _{DD} = 30 V, V _{GS} = 10 V, I _{PK} = 21 A, L = 1 mH, R _G = 25 Ω)			E _{AS}	220	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	56.3	°C/W
Junction-to-Ambient – t \leq 10 s (Note 1)	$R_{\theta JA}$	21.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	141.6	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 in sq pad size

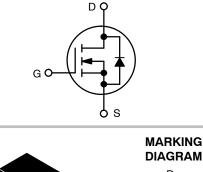
- (Cu area = 1.127 in sq [1 oz] including traces).
- 2. Surface mounted on FR4 board using the minimum recommended pad size (Cu area = 0.0264 in sq).

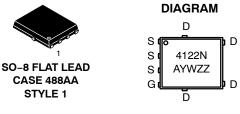


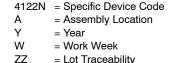
ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX (Note 1)
30 V	4.6 mΩ @ 10 V	23 A
30 V	6.3 mΩ @ 4.5 V	23 A







= Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4122NT1G	SO-8 FL (Pb-Free)	1500 Tape & Reel
NTMFS4122NT3G	SO-8 FL (Pb-Free)	5000 Tape & Reel

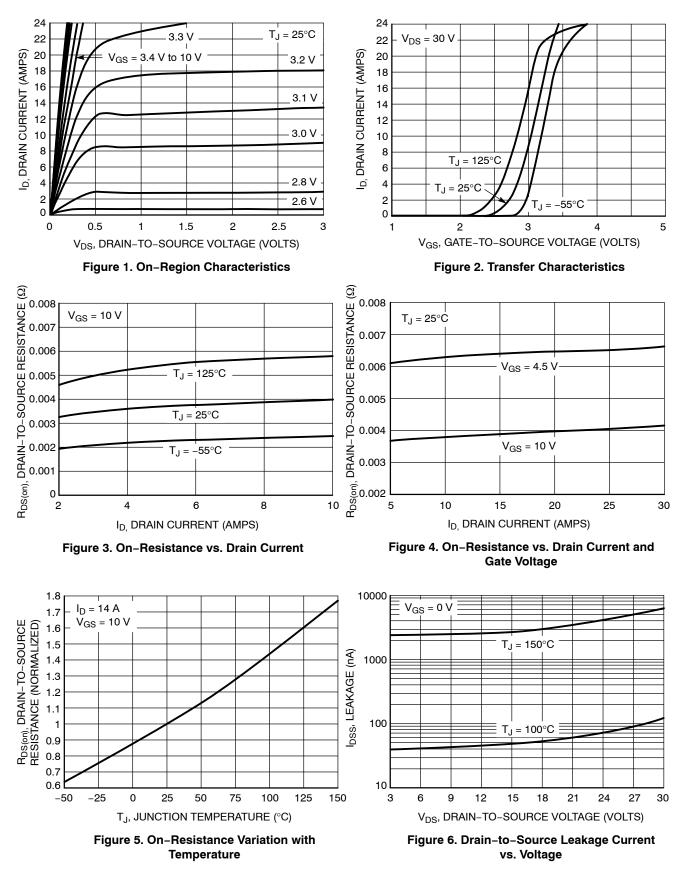
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

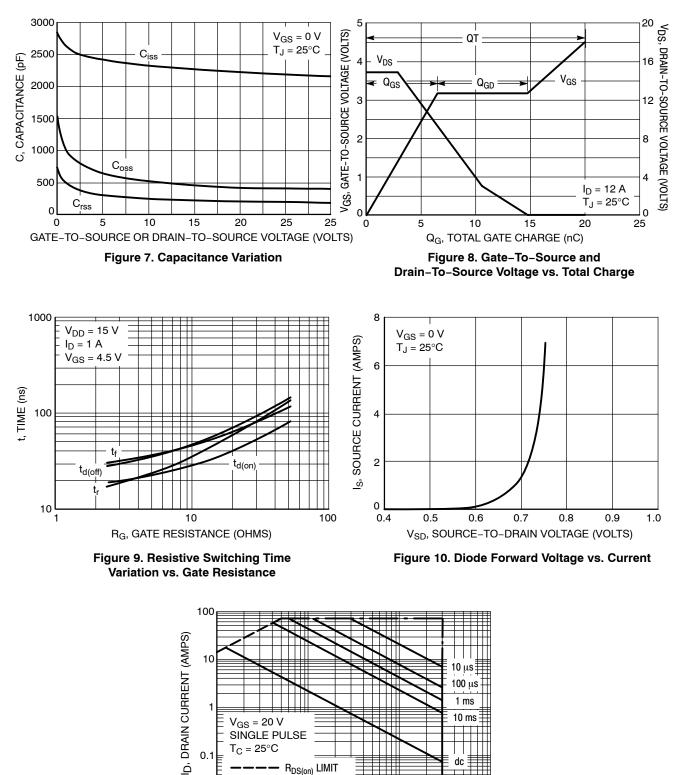
Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-	•		-	-		-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				23		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 24 V	T _J = 25°C			1.0	μΑ
			T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =				100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.0		2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				6.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 14 A			4.6	6.0	mΩ
		V _{GS} = 4.5 V, I _D = 12 A			6.3	8.5	1
Forward Transconductance	9 FS	V _{DS} = 15 V, I _D = 10 A			13.2		S
CHARGES, CAPACITANCES AND GATE R	ESISTANCE				•		•
Input Capacitance	C _{ISS}				2310		pF
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1.0 MHz, V_{DS} = 24 V			460		
Reverse Transfer Capacitance	C _{RSS}				263		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V, I _D = 12 A			20	30	nC
Threshold Gate Charge	Q _{G(TH)}				3.0		1
Gate-to-Source Charge	Q _{GS}				6.7		1
Gate-to-Drain Charge	Q _{GD}				8.1		1
Gate Resistance	R _G				0.7		Ω
SWITCHING CHARACTERISTICS (Note 4)					•		
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 1.0 A, R _L = 15 Ω, R _G = 3.0 Ω			20		ns
Rise Time	t _r				20		-
Turn-Off Delay Time	t _{d(OFF)}				30		
Fall Time	t _f				31		
DRAIN-SOURCE DIODE CHARACTERISTI	cs						
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I _S = 7.0 A	$T_J = 25^{\circ}C$		0.75	1.0	V
-			T _J = 125°C		0.6		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 7.0 A			28		ns
Charge Time	t _a				14		1
Discharge Time	t _b				14		
Reverse Recovery Charge	Q _{RR}				23		nC

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES



http://onsemi.com 4

V_{DS}, DRAIN-TO-SOURCE VOLTAGE (VOLTS) Figure 11. Maximum Rated Forward Biased Safe Operating Area

10

R_{DS(on)} LIMIT THERMAL LIMIT PACKAGE LIMIT

1

0.01 0.1 dc

100





onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters, including "Typicals" must be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcula performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Onsemi: NTMFS4122NT1G NTMFS4122NT3G